

#### 1.5A SURFACE MOUNT FAST RECOVERY RECTIFIER

#### **Features**

- Glass Passivated Die Construction
- Fast Recovery Time For High Efficiency
- Surge Overload Rating to 50A Peak
- Ideally Suited for Automated Assembly
- Lead Free Finish/RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony) (Note 2)

## **Mechanical Data**

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (3):
- Polarity: Cathode Band or Cathode Notch
- SMA Weight: 0.065 grams (approximate)
- SMB Weight: 0.09 grams (approximate)





Top View

**Bottom View** 

# PDF Support

### Ordering Information (Note 3)

Part Number	Case	Packaging
RS2xA-13-F	SMA	5000/Tape & Reel
RS2x-13-F	SMB	3000/Tape & Reel

<sup>\*</sup>x = Device type, e.g. RS2DA-13-F (SMA package); RS2J-13-F (SMB package).

Notes:

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- 2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
- 3. For packaging details, go to our website at http://www.diodes.com.

# **Marking Information**





## Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	RS2 A/AA	RS2 B/BA	RS2 D/DA	RS2 G/GA	RS2 J/JA	RS2 K/KA	RS2 M/MA	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 4)	$egin{array}{c} V_{RRM} \ V_{R} \end{array}$	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V
Average Rectified Output Current @ T <sub>T</sub> = 120°C	lo				1.5				Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>				50				Α

### **Thermal Characteristics**

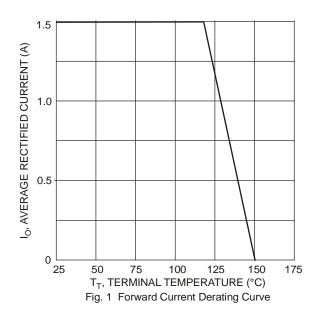
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Terminal (Note 5)	$R_{\theta JT}$	20	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-65 to +150	°C

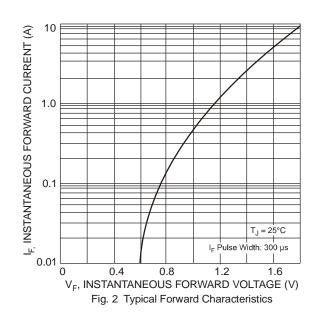
## **Electrical Characteristics** @TA = 25°C unless otherwise specified

Characteristic		Symbol	RS2 A/AA	RS2 B/BA	RS2 D/DA	RS2 G/GA	RS2 J/JA	RS2 K/KA	RS2 M/MA	Unit
Forward Voltage	@ I <sub>F</sub> = 1.5A	$V_{FM}$				1.3				V
Peak Reverse Current	@ $T_A = 25^{\circ}C$	A = 25°C 5.0								
at Rated DC Blocking Voltage (Note 4)	@ $T_A = 125^{\circ}C$	I <sub>RM</sub>				200	_			μА
Reverse Recovery Time (Note 6)		t <sub>rr</sub>		15	50		250	50	00	ns
Typical Total Capacitance (Note 7)		C <sub>T</sub>				30				pF

Notes:

- 4. Short duration pulse test used to minimize self-heating effect.
- 5. Reverse recovery test conditions:  $I_F = 0.5A$ ,  $I_R = 1.0A$ ,  $I_{rr} = 0.25A$ . See Figure 5.
  6. Thermal Resistance: Junction to terminal, unit mounted on PC board with 5.0 mm<sup>2</sup> (0.013 mm thick) copper pads as heat sink.
- 7. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.







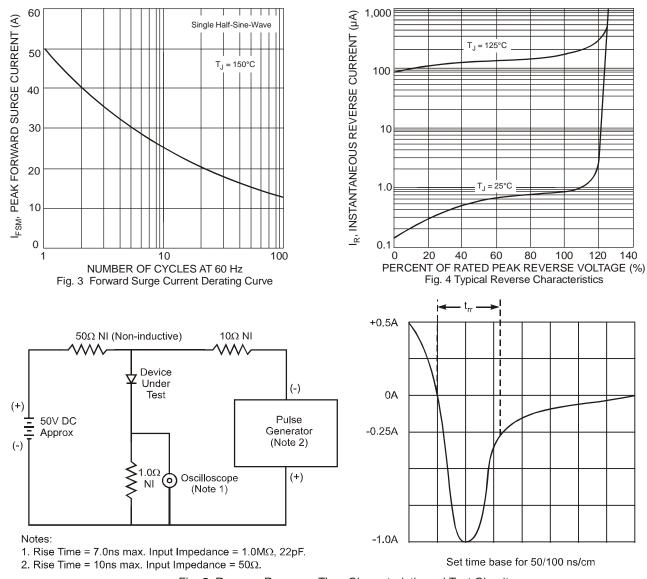
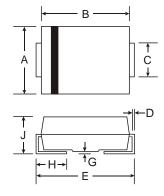


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

# **Package Outline Dimensions**

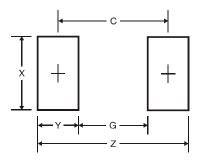


	SMA				
Dim	Min	Max			
Α	2.29	2.92			
В	4.00	4.60			
С	1.27	1.63			
D	0.15	0.31			
Е	4.80	5.59			
G	0.05	0.20			
Н	0.76	1.52			
J	2.01	2.30			
<b>All Dim</b>	All Dimensions in mm				

SMB				
Dim	Min	Max		
Α	3.30	3.94		
В	4.06	4.57		
С	1.96	2.21		
D	0.15	0.31		
E	5.00 5.59			
G	0.05 0.20			
Н	0.76 1.52			
7	2.00	2.50		
All Dimensions in mm				



#### Suggested Pad Layout



SMA Dimensions	Value (in mm)
Z	6.5
G	1.5
Х	1.7
Υ	2.5
С	4.0

SMB Dimensions	Value (in mm)
Z	6.7
G	1.8
Х	2.3
Υ	2.5
С	4.3

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